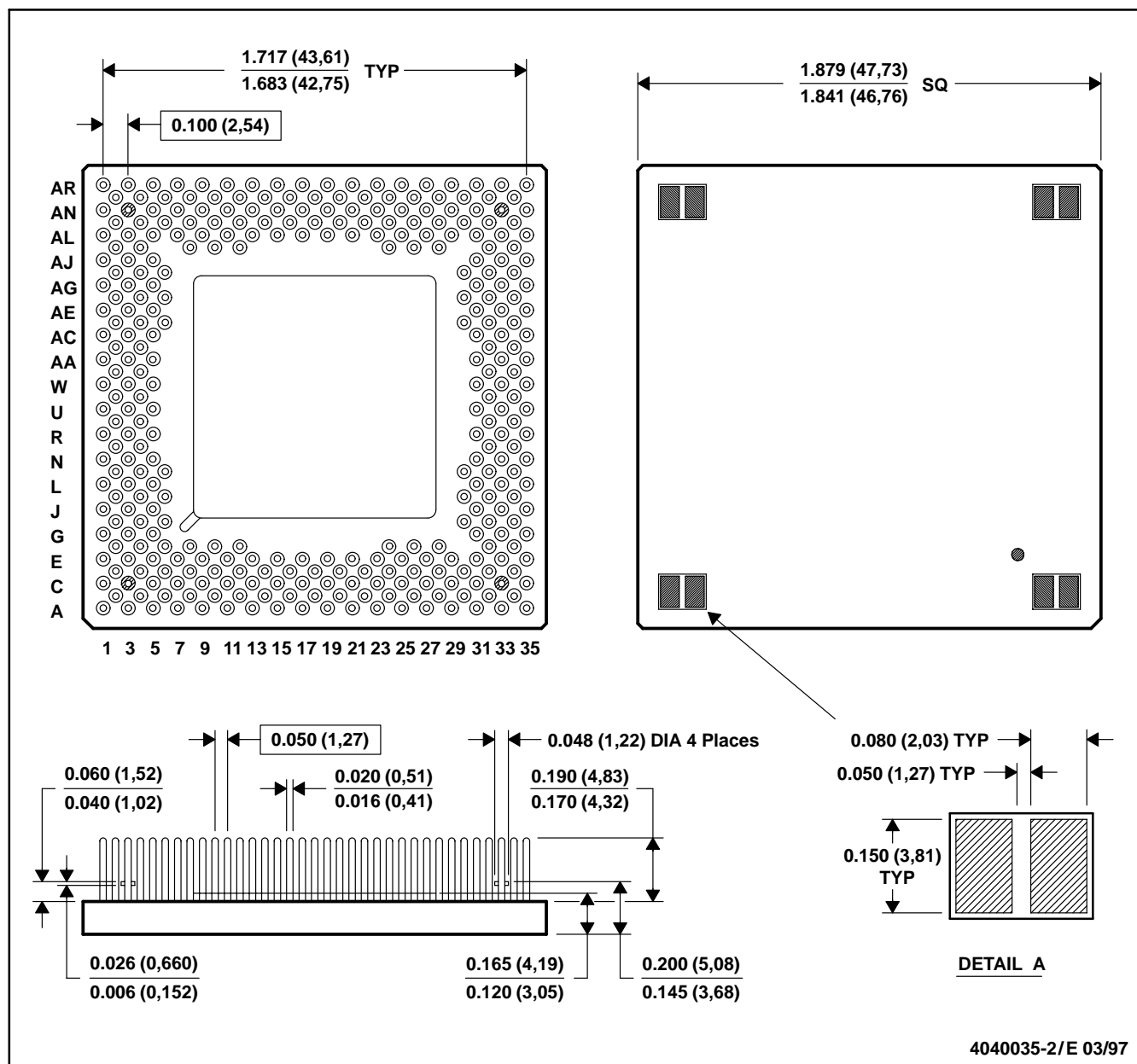


## GF (S-CPGA-P325)

## CERAMIC PIN GRID ARRAY



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Package thickness of 0.165 (4,19) / 0.120 (3,05) includes package body and lid.

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